

- As MD device, the TECS had a dedicated BIC entry in LSS2: device had to be out for normal operation
- Moving to operational device, this was supposed to be reversed to ensure device in beam
- The interlock only checks if crystal at the end switches (crystal could be almost out and interlock still be OK...)
- HW interlock not possible for position or angle at the moment → done via SIS
- No risk for the machine or ZS (see previous talk at the MPP)
- Propose to completely remove the HW interlock and rely only on SIS for the moment
- For the future, investigate possibility to HW interlock on position and angle with sufficient accuracy for smooth and safe operation